n For U.S. Patent Appli

As a below named inventor, I hereby declare that:

My	residence,	post office	address and	d citizenship	o are as stated	below next	to my name.
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the specification of v	which is attached hereto unless the follow		N. W. W. W. W. W.	DCT Internations			
	as filed on						
		ation 1 tolloos					
•	applicable).						
I hereby state that I by any amendment r	have reviewed and understand the conter referred to above.	ts of the above-identified	d specification, including the claim	m(s), as amended			
Lacknowledge the di	ity to disclose information which is mater	ial to patentability as defi	ned in Title 37, Code of Federal R	Regulations, § 1.56			
يعرز							
I hereby claim foreig	gn priority henefits under Title 35, United listed below and have also identified be	l States Code, § 119 (a) - low any foreign applicati	on for patent or inventor's certifi	cate having a fil-			
inventor's certificate ing date before that (of the application on which priority is cla	nimed:	F	_			
u.	·· -	•		Priority Claime			
(List prior	239771/1999	JAPAN	26/8/1999	_ Xi Yes D No			
foreign	(Number) 041887/2000	(Country) JAPAN	(Day/Month/Year Filed) 18/2/2000	X Yes No			
applications. See note A	(Number) 187580/2000	(Country) JAPAN	(Day/Month/Year Filed) 22/6/2000	— - Xo Yes □ No			
on back of this page)	(Number)	(Country)	(Day/Month/Year Filed)	☐ Yes ☐ No			
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		t 11-4 for additional anions	foreign applications				
(See note B on back	of this page)	i list for additional prior					
(See note B on back	1 0 /			listed below.			
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I hereby declare that all statements mad herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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